



SD2931-11

RF power transistors HF/VHF/UHF N-channel MOSFETs

Features

- Gold metallization
- Excellent thermal stability
- Common source configuration
- $P_{OUT} = 150\text{ W min. with } 14\text{ dB gain @ } 175\text{ MHz}$
- Thermally enhanced packaging for lower junction temperatures
- G_{FS} and V_{GS} sort marked on unit

Description

The SD2931-11 is a gold metallized N-channel MOS field-effect RF power transistor. Being electrically identical to the standard SD2931 MOSFET, it is intended for use in 50 V dc large signal applications up to 230 MHz.

The SD2931-11 is mechanical compatible to the SD2931 but offers in addition a better thermal capability (25% lower thermal resistance), representing the best-in-class transistors for ISM applications, where reliability and ruggedness are critical factors.

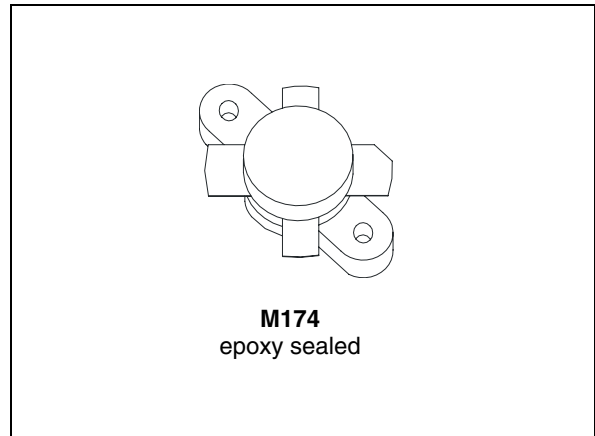


Figure 1. Pin connection

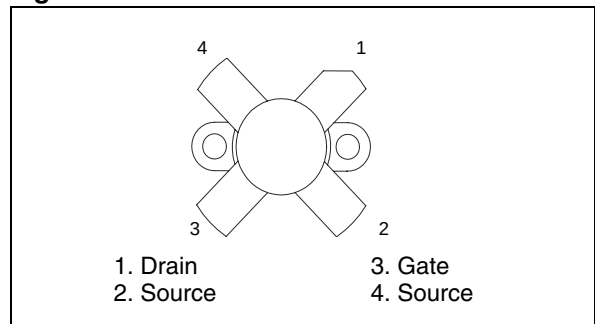


Table 1. Device summary

Order code	Marking	Package	Packing
SD2931-11	SD2931-11	M174 epoxy sealed	Tray

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1 Electrical data

1.1 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}$	Drain source voltage	125	V
V_{DGR}	Drain-gate voltage ($R_{GS} = 1M\Omega$)	125	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current	20	A
P_{DISS}	Power dissipation	389	W
T_j	Max. operating junction temperature	200	°C
T_{STG}	Storage temperature	-65 to +150	°C

1.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction -case thermal resistance	0.45	°C/W

2 Electrical specification

($T_{CASE} = 25\text{ °C}$).

Table 4. Static

Symbol	Test conditions			Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}$	$I_{DS} = 100\text{ mA}$		125			V
I_{DSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 50\text{ V}$				50	μA
I_{GSS}	$V_{GS} = 20\text{ V}$	$V_{DS} = 0\text{ V}$				250	nA
$V_{GS(Q)}^{(1)}$	$V_{DS} = 10\text{ V}$	$I_D = 250\text{ mA}$		see table below			V
$V_{DS(ON)}$	$V_{GS} = 10\text{ V}$	$I_D = 10\text{ A}$				3.0	V
G_{FS}^*	$V_{DS} = 10\text{ V}$	$I_D = 5\text{ A}$		see table below			mho
C_{ISS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 50\text{ V}$	$f = 1\text{ MHz}$		480		pF
C_{OSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 50\text{ V}$	$f = 1\text{ MHz}$		190		pF
C_{RSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 50\text{ V}$	$f = 1\text{ MHz}$		18		pF

1. $V_{GS(Q)}$ and G_{FS} sorted with alpha/numeric code marked on unit.

Table 5. Dynamic

Symbol	Test conditions			Min.	Typ.	Max.	Unit
P_{OUT}	$V_{DD} = 50\text{ V}$	$I_{DQ} = 250\text{ mA}$	$f = 175\text{ MHz}$	150			W
G_{PS}	$V_{DD} = 50\text{ V}$	$I_{DQ} = 250\text{ mA}$	$P_{OUT} = 150\text{ W}$	14	15		dB
h_D	$V_{DD} = 50\text{ V}$	$I_{DQ} = 250\text{ mA}$	$P_{OUT} = 150\text{ W}$	55	65		%
Load Mismatch	$V_{DD} = 50\text{ V}$	$I_{DQ} = 250\text{ mA}$	$P_{OUT} = 150\text{ W}$	10:1			VSW R

Table 6. V_{GS} and G_{FS} sorts

Code	V_{GS}		G_{FS}		Code	V_{GS}		G_{FS}	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	2.4	2.65	5.0	5.5	J	2.65	3.15	6.5	7.0
B	2.4	2.65	5.5	6.0	K	2.65	3.15	7.0	7.5
C	2.4	2.65	6.0	6.5	L	2.65	3.15	7.5	8.0
D	2.4	2.65	6.5	7.0	M	3.15	3.3	5.0	5.5
E	2.4	2.45	7.0	7.5	N	3.15	3.3	5.5	6.0
F	2.4	2.65	7.5	8.0	O	3.15	3.3	6.0	6.5
G	2.65	3.15	5.0	5.5	P	3.15	3.3	6.5	7.0
H	2.65	3.15	5.5	6.0	Q	3.15	3.3	7.0	7.5
I	2.65	3.15	6.0	6.5	R	3.15	3.3	7.5	8.0

3 Impedance data

Figure 2. Impedance data

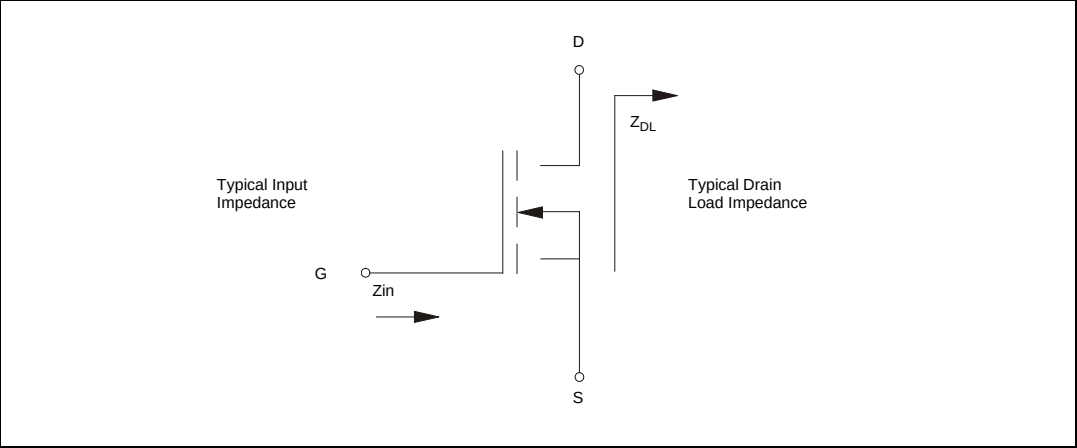


Table 7. Impedance data

Freq	$Z_{IN} (\Omega)$	$Z_{DL} (\Omega)$
30 MHz	$1.7 - j 5.7$	$6.8 + j 0.9$
175 MHz	$1.2 - j 2.0$	$2.0 + j 2.4$

4 Typical performance

Figure 3. Capacitance vs drain-source voltage

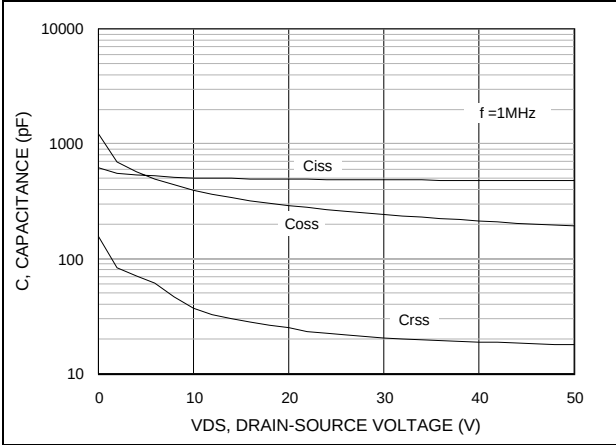


Figure 4. Drain current vs gate voltage

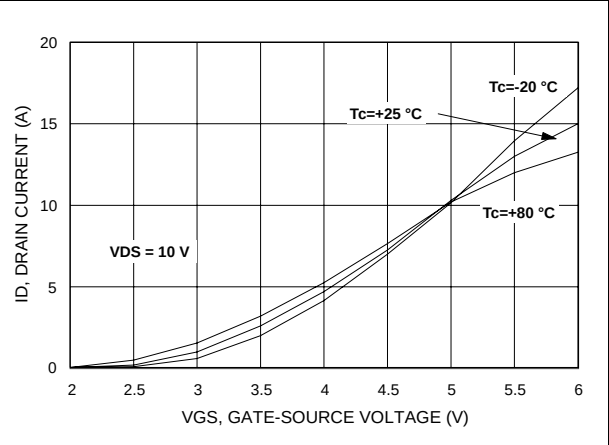


Figure 5. Gate-source voltage vs case temperature

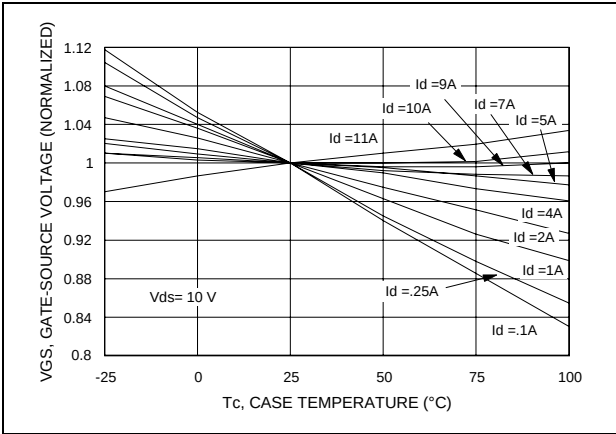


Figure 6. Maximum thermal resistance vs case temperature

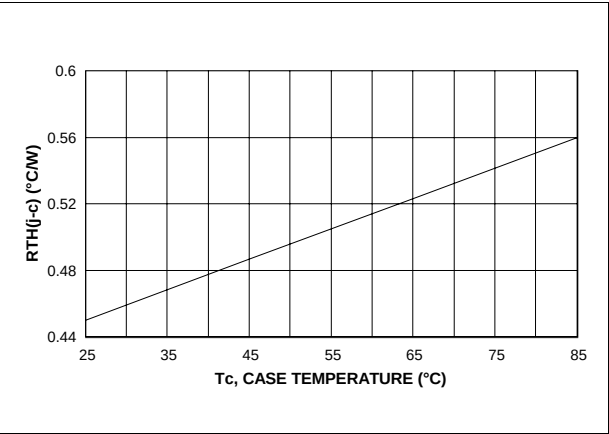
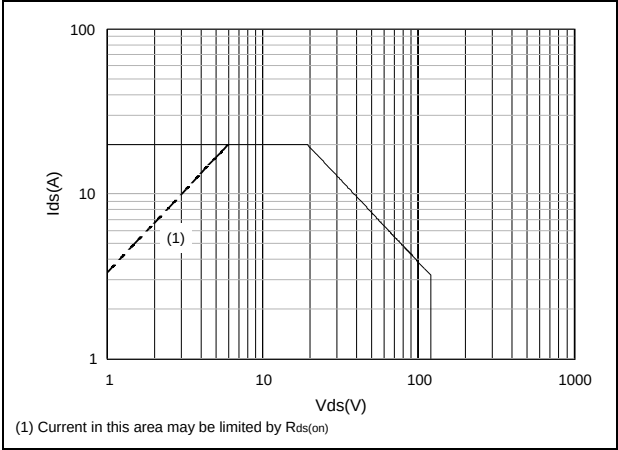


Figure 7. Safe operating area



5 Typical performance 175 MHz

Figure 8. Output power vs input power

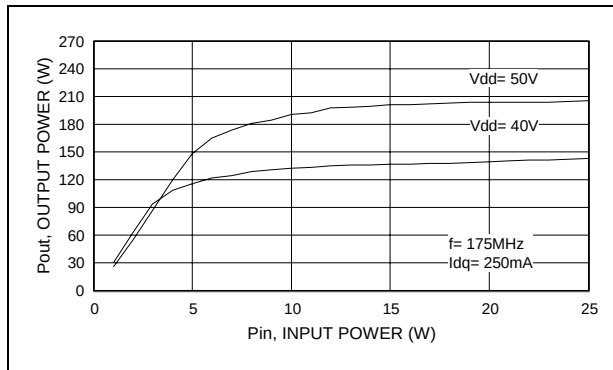


Figure 9. Output power vs input power at different temperatures

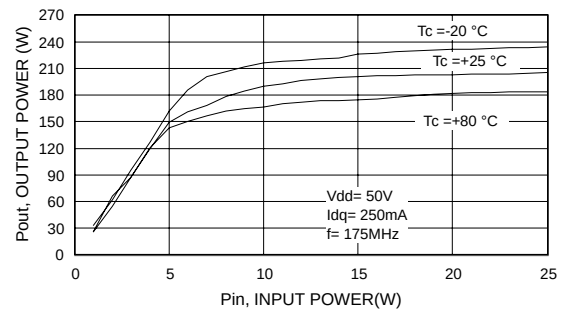


Figure 10. Power gain vs output power

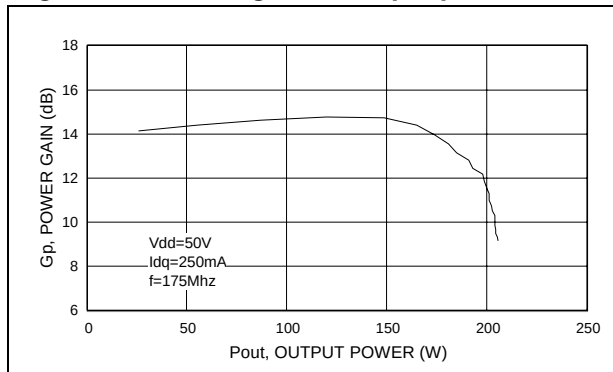


Figure 11. Efficiency vs output power

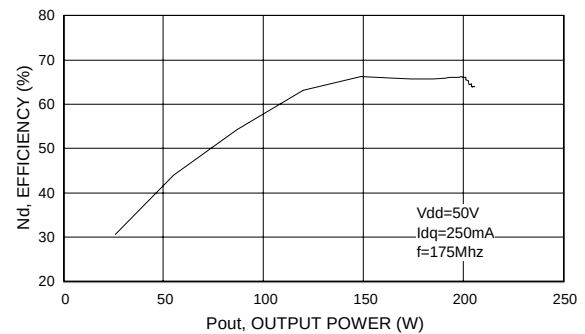


Figure 12. Output power vs supply voltage

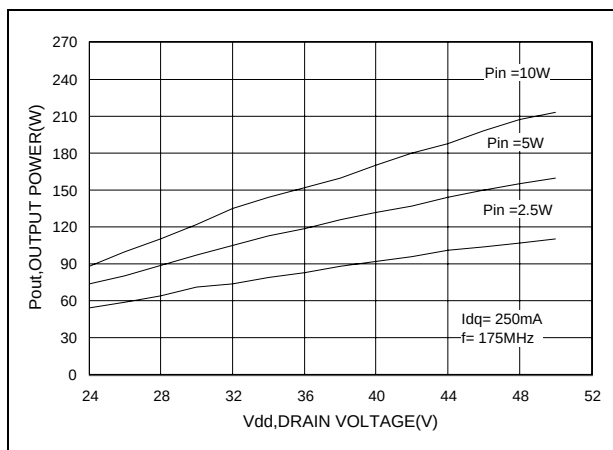
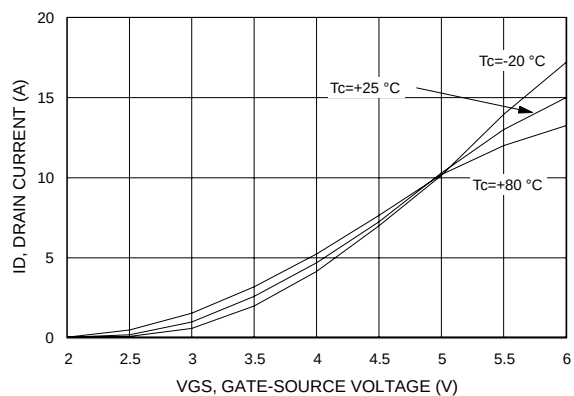


Figure 13. Drain current vs gate-source voltage



6 Test circuit

Figure 14. 175 MHz test circuit schematic (production test circuit)

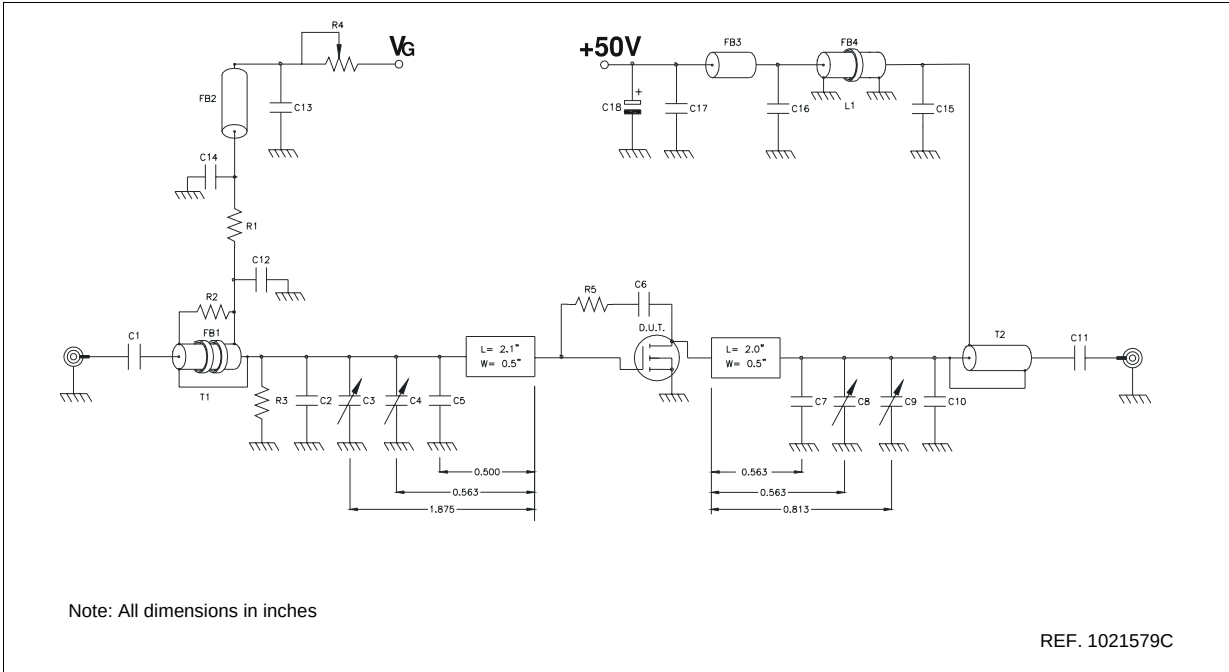


Table 8. Component part list

Component	Description
T1	4:1 transformer, 25 ohm flexible coax .090 OD 6" long
T2	1:4 transformer, 25 ohm semi-rigid coax .141 OD 6" long
FB1	Toroid X 2, 0.5" OD .312" ID 850μ 2 turns
FB2, FB3	VK200
FB4	Shield bead, 1" OD 0.5" ID 850μ 3 turns
L1	1/4 wave choke, 50 ohm semi-rigid coax .141 OD 12" Long
PCB	0.62" woven fiberglass, 1 oz. copper, 2 sides, $\epsilon_r = 2.55$
R1, R3	470 ohm 1 W chip resistor
R2	360 ohm 1/2 W resistor
R4	20 Kohm 10 turn potentiometer
R5	560 ohm 1 W resistor
C1, C11	470 pF ATC chip cap
C2	43 pF ATC chip cap
C3, C8, C9	Arco 404, 12-65 pF
C4	Arco 423, 16-100 pF

Table 8. Component part list (continued)

Component	Description
C5	120 pF ATC chip cap
C6	0.01 μ F ATC chip cap
C7	30 pF ATC chip cap
C10	91 pF ATC chip cap
C12, C15	1200 pF ATC chip cap
C13, C14, C16, C17	0.01 μ F / 500 V chip cap
C18	10 μ F 63 V electrolytic capacitor

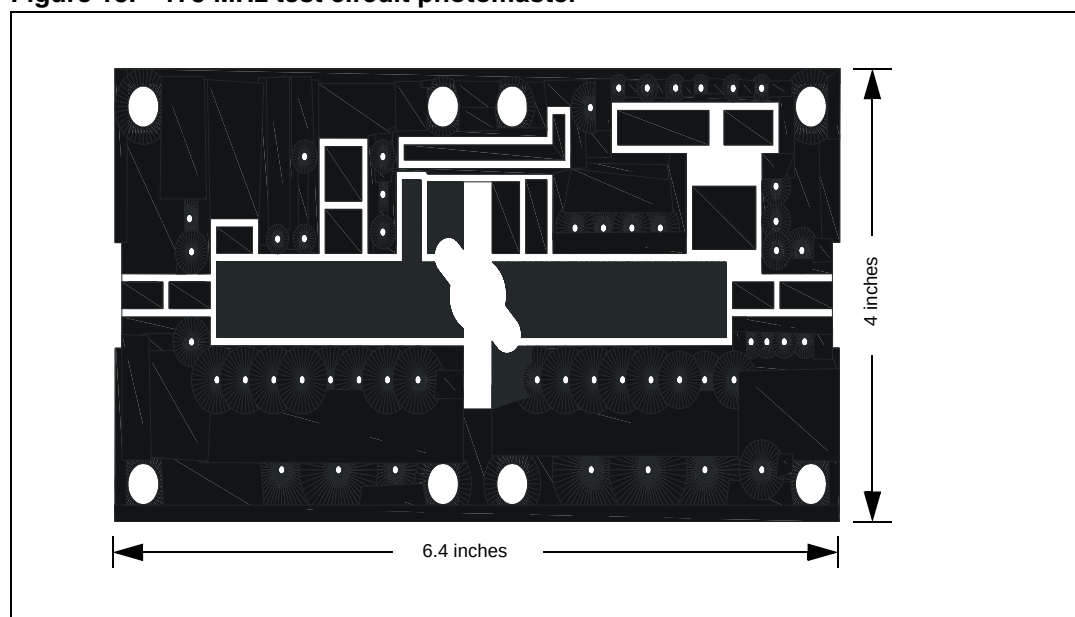
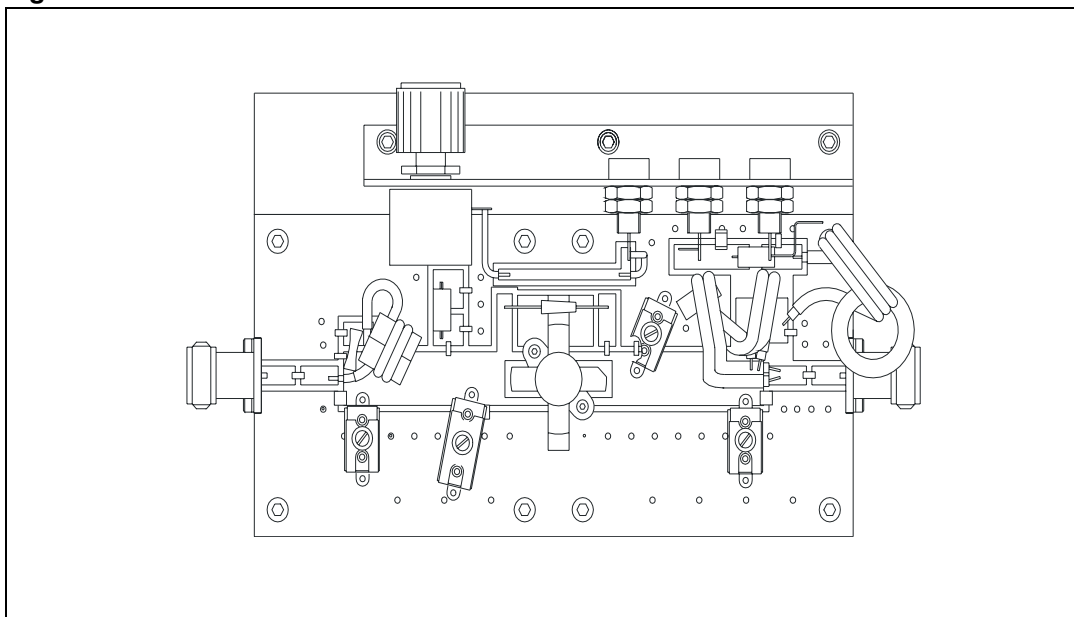
Figure 15. 175 MHz test circuit photomaster

Figure 16. 175 MHz test circuit

7 Typical performance 30 MHz

Figure 17. Output power vs input power

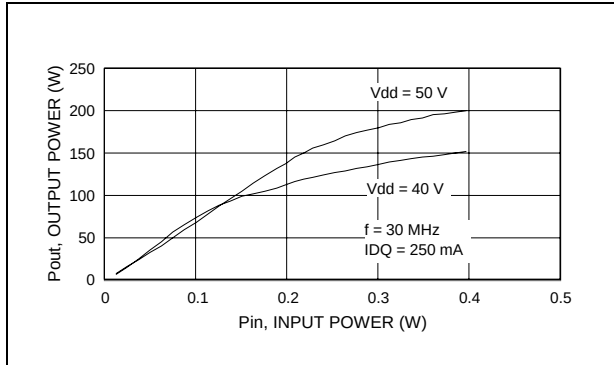


Figure 18. Power gain vs output power

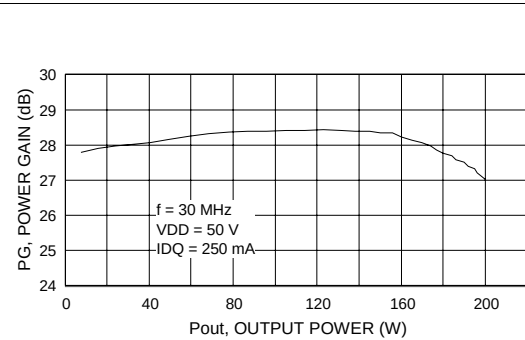


Figure 19. Efficiency vs output power

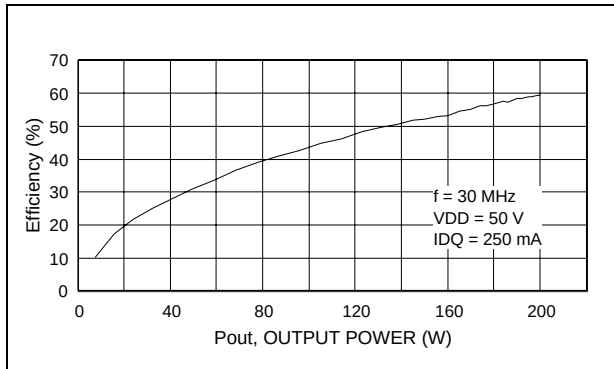


Figure 20. Output power vs supply voltage

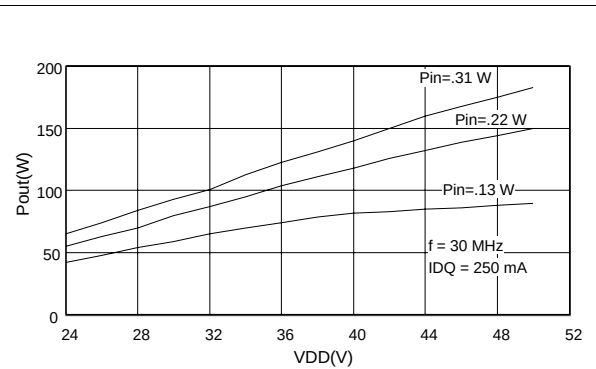
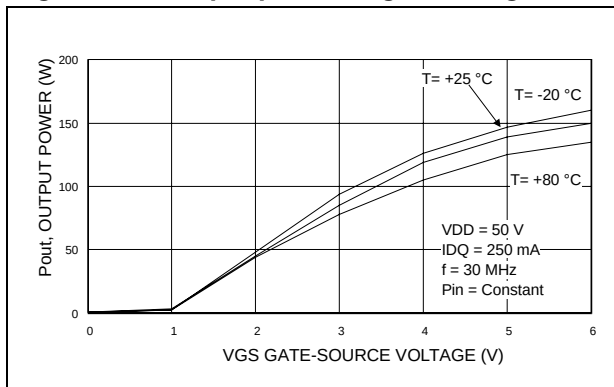


Figure 21. Output power vs gate voltage



8 Test circuit 30 MHz

Figure 22. 30 MHz test circuit schematic (engineering test circuit)

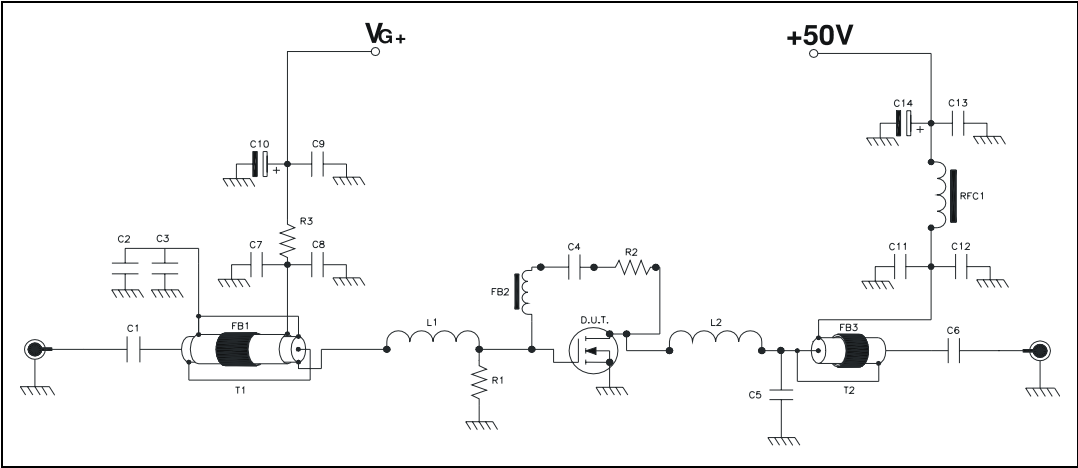


Figure 23. 30 MHz test circuit component part list

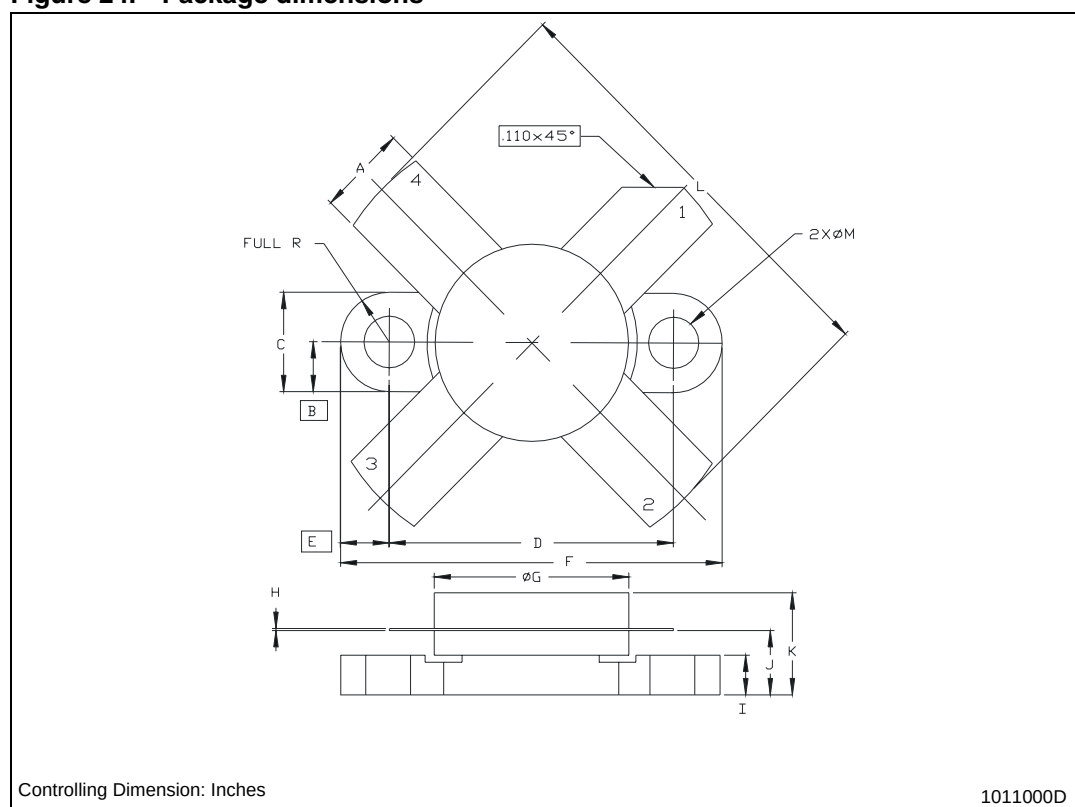
Symbol	Description
T1	9:1 transformer, 25 Ω flexible coax with extra shield .090 OD 15" long
T2	1:4 transformer, 50 Ω flexible coax .225 OD 15" long
FB1	Toroid 1.7" OD .30" ID 220 μ 4 turns
FB2	Surface mount EMI shield bead
FB3	Toroid 1.7" OD .300" ID 220 μ 3 turns
RFC1	Toroid 0.5" OD 0.30" ID 125 μ 4 turns 12 awg wire
PCB	0.62" Woven Fiberglass, 1 oz. Copper, 2 Sides, $\epsilon r = 2.55$
R1, R3	1 K Ω 1 W chip resistor
R2	680 Ω 3 W wirewound resistor
C1,C4,C6,C7,C8, C9,C11,C12,C13	0.1 μ F ATC chip cap
C2,C3	750 pF ATC chip cap
C5	470 pF ATC chip cap
C10	10 μ F 63 V electrolytic capacitor
C14	100 μ F 63 V electrolytic capacitor

9 Package mechanical data

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Table 9. M174 (0.500 DIA 4/L N/HERM W/FLG) mechanical data

Dim.	mm.			Inch		
	Min	Typ	Max	Min	Typ	Max
A	5.56		5.584	0.219		0.230
B		3.18			0.125	
C	6.22		6.48	0.245		0.255
D	18.28		18.54	0.720		0.730
E		3.18			0.125	
F	24.64		24.89	0.970		0.980
G	12.57		12.83	0.495		0.505
H	0.08		0.18	0.003		0.007
I	2.11		3.00	0.083		0.118
J	3.81		4.45	0.150		0.175
K			7.11			0.280
L	25.53		26.67	1.005		1.050
M	3.05		3.30	0.120		0.130

Figure 24. Package dimensions

10 Revision history

Table 10. Document revision history

Date	Revision	Changes
30-Mar-2010	1	Initial release.

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